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Kind regards,

Team Nexperia

8-bit level-shifting bus switch with 4-bit output enables Rev. 2 — 16 December 2011 Product da

Product data sheet

#### 1. **General description**

The 74CBTLVD3244 is a dual 4-pole, single-throw bus switch. The device features two output enable inputs (nOE) that each control four switch channels. The switches are disabled when the associated nOE input is HIGH. Schmitt trigger action at control inputs makes the circuit tolerant of slower input rise and fall times. This device is fully specified for partial power-down applications using I<sub>OFF</sub>. The I<sub>OFF</sub> circuitry disables the output, preventing the damaging backflow current through the device when it is powered down.

#### 2. **Features and benefits**

- Supply voltage range from 3.0 V to 3.6 V
- High noise immunity
- Complies with JEDEC standard:
  - JESD8-B/JESD36 (3.0 V to 3.6 V)
- ESD protection:
  - HBM JESD22-A114F exceeds 2000 V
  - CDM AEC-Q100-011 revision B exceeds 1000 V
- 5 Ω switch connection between two ports
- Rail to rail switching on data I/O ports
- CMOS low power consumption
- Latch-up performance exceeds 250 mA per JESD78B Class I level A
- I<sub>OFF</sub> circuitry provides partial Power-down mode operation
- Multiple package options
- Specified from -40 °C to +85 °C and -40 °C to +125 °C



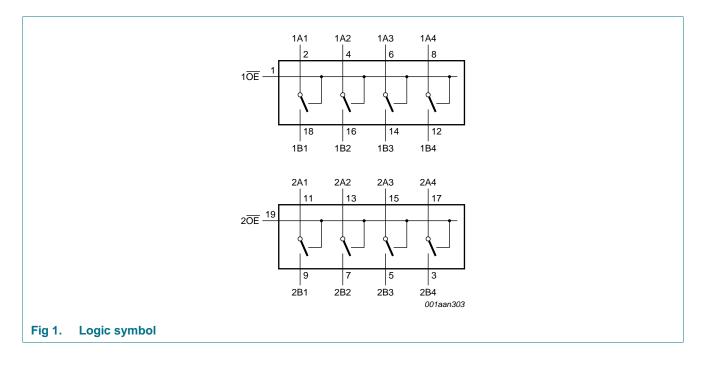
8-bit level-shifting bus switch with 4-bit output enables

## 3. Ordering information

Table 1. Ordering	Table 1. Ordering information								
Type number	Package								
	Temperature range	Name	Description	Version					
74CBTLVD3244DS	–40 °C to +125 °C	SSOP20 <sup>[1]</sup>	plastic shrink small outline package; 20 leads; body width 3.9 mm; lead pitch 0.635 mm	SOT724-1					
74CBTLVD3244PW	–40 °C to +125 °C	TSSOP20	plastic thin shrink small outline package; 20 leads; body width 4.4 mm	SOT360-1					
74CBTLVD3244BQ	–40 °C to +125 °C	DHVQFN20	plastic dual-in-line compatible thermal enhanced very thin quad flat package; no leads; 20 terminals; body $2.5 \times 4.5 \times 0.85$ mm	SOT764-1					

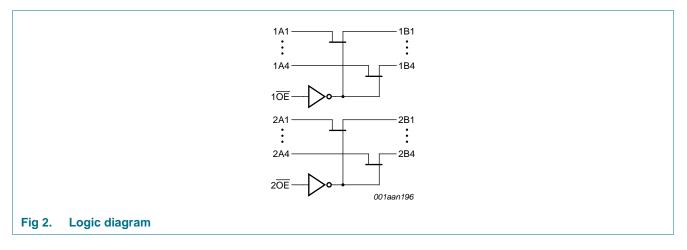
[1] Also known as QSOP20 package

## 4. Functional diagram

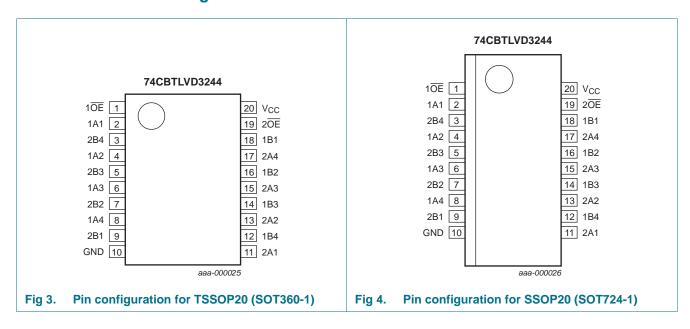


## 74CBTLVD3244

#### 8-bit level-shifting bus switch with 4-bit output enables



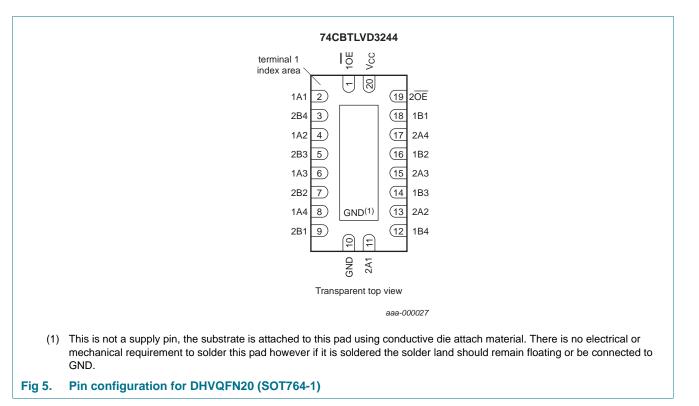
#### 5. Pinning information



#### 5.1 Pinning

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#### 8-bit level-shifting bus switch with 4-bit output enables



#### 5.2 Pin description

#### Table 2.Pin description

Symbol	Pin	Description
$1\overline{OE}, 2\overline{OE}$	1, 19	output enable input (active LOW)
1A1 to 1A4	2, 4, 6, 8	data input/output (A port)
2B1 to 2B4	9, 7, 5, 3	data input/output (A port)
GND	10	ground (0 V)
2A1 to 2A4	11, 13, 15, 17	data input/output (B port)
1B1 to 1B4	18, 16, 14, 12	data input/output (B port)
V <sub>CC</sub>	20	positive supply voltage

#### 6. Functional description

# Input Input/output nOE nAn, nBn L nAn = nBn H Z

[1] H = HIGH voltage level; L = LOW voltage level; Z = high-impedance OFF-state.

8-bit level-shifting bus switch with 4-bit output enables

#### 7. Limiting values

#### Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC</sub>	supply voltage		-0.5	+4.6	V
VI	input voltage		<u>[1]</u> –0.5	+4.6	V
V <sub>SW</sub>	switch voltage	enable and disable mode	<u>[1]</u> –0.5	$V_{CC} + 0.5$	V
I <sub>IK</sub>	input clamping current	$V_{I/O} < -0.5 V$	-50	-	mA
I <sub>SK</sub>	switch clamping current	$V_{I} < -0.5 V$	-50	-	mA
I <sub>SW</sub>	switch current	$V_{SW} = 0 V$ to $V_{CC}$	-	±128	mA
I <sub>CC</sub>	supply current		-	+100	mA
I <sub>GND</sub>	ground current		-100	-	mA
T <sub>stg</sub>	storage temperature		-65	+150	°C
P <sub>tot</sub>	total power dissipation	$T_{amb} = -40 \text{ °C to } +125 \text{ °C}$	[2] _	500	mW

[1] The minimum input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] For SSOP20 and TSSOP20 packages: above 60 °C the value of Ptot derates linearly at 5.5 mW/K.

For DHVQFN20 packages: above 60 °C the value of Ptot derates linearly at 4.5 mW/K.

#### 8. Recommended operating conditions

Table 5.	Recommended	operating	conditions
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Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC</sub>	supply voltage		3.0	3.6	V
VI	input voltage		0	3.6	V
V <sub>SW</sub>	switch voltage	enable and disable mode	0	V <sub>CC</sub>	V
T <sub>amb</sub>	ambient temperature		-40	+125	°C
$\Delta t / \Delta V$	input transition rise and fall rate	$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	<u>[1]</u> 0	200	ns/V

[1] Applies to control signal levels.

#### 9. Static characteristics

#### Table 6.Static characteristics

At recommended operating conditions voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	T <sub>amb</sub> = -	-40 °C to ·	+85 °C	T <sub>amb</sub> = -40 °	C to +125 °C	Unit
			Min	Typ <mark>[1]</mark>	Max	Min	Max	
V <sub>IH</sub>	HIGH-level input voltage	$V_{CC} = 3.0 V \text{ to } 3.6 V$	2.0	-	-	2.0	-	V
V <sub>IL</sub>	LOW-level input voltage	$V_{CC} = 3.0 V \text{ to } 3.6 V$	-	-	0.9	-	0.9	V
l	input leakage current	pin n $\overline{OE}$ ; V <sub>I</sub> = GND to V <sub>CC</sub> ; V <sub>CC</sub> = 3.6 V	-	-	±1	-	±20	μΑ
V <sub>pass</sub>	pass voltage	$V_I = V_{CC}$ ; see <u>Figure 8</u> to <u>Figure 12</u>	-	-	-	-	-	V

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74CBTLVD3244

## 74CBTLVD3244

#### 8-bit level-shifting bus switch with 4-bit output enables

Symbol	Parameter	Conditions		T <sub>amb</sub> = ·	–40 °C to	+85 °C	T <sub>amb</sub> = -40 °	C to +125 °C	Unit
				Min	Typ <mark>[1]</mark>	Max	Min	Max	1
I <sub>S(OFF)</sub>	OFF-state leakage current	$V_{CC} = 3.6 V$ ; see Figure 6		-	-	±1	-	±20	μA
I <sub>S(ON)</sub>	ON-state leakage current	$V_{CC}$ = 3.6 V; see Figure 7		-	-	±1	-	±20	μA
I <sub>OFF</sub>	power-off leakage current	$V_1 \text{ or } V_0 = 0 \text{ V to } 3.6 \text{ V};$ $V_{CC} = 0 \text{ V}$		-	-	±10	-	±50	μA
I <sub>CC</sub>	supply current	$\label{eq:VI} \begin{array}{l} V_{I} = V_{CC}; \ I_{O} = 0 \ A; \ V_{CC} = 3.6 \ V; \\ V_{SW} = GND \ or \ V_{CC} \end{array}$		-	-	20	-	50	μA
		$V_{I} = \text{GND}; I_{O} = 0 \text{ A};$ $V_{CC} = 3.6 \text{ V};$ $V_{SW} = \text{GND or } V_{CC}$		-	-	100	-	150	μΑ
$\Delta I_{CC}$	additional supply current	pin n $\overline{OE}$ ; V <sub>1</sub> = V <sub>CC</sub> – 0.6 V; V <sub>SW</sub> = GND or V <sub>CC</sub> ; V <sub>CC</sub> = 3.6 V	[2]	-	-	300	-	2000	μΑ
CI	input capacitance	pin n $\overline{OE}$ ; V <sub>CC</sub> = 3.3 V; V <sub>I</sub> = 0 V to 3.3 V		-	0.9	-	-	-	pF
$C_{S(OFF)}$	OFF-state capacitance	$V_{CC}$ = 3.3 V; $V_{I}$ = 0 V to 3.3 V		-	2.5	-	-	-	pF
C <sub>S(ON)</sub>	ON-state capacitance	$V_{CC}$ = 3.3 V; $V_{I}$ = 0 V to 3.3 V		-	9.0	-	-	-	pF

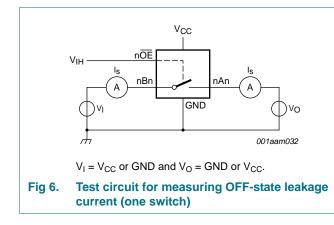
#### Table 6. Static characteristics ... continued

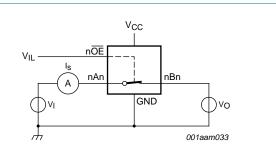
At recommended operating conditions voltages are referenced to GND (ground = 0 V).

[1] All typical values are measured at  $T_{amb} = 25 \text{ °C}$ .

[2] One input at 3 V, other inputs at  $V_{CC}$  or GND.

#### 9.1 Test circuits

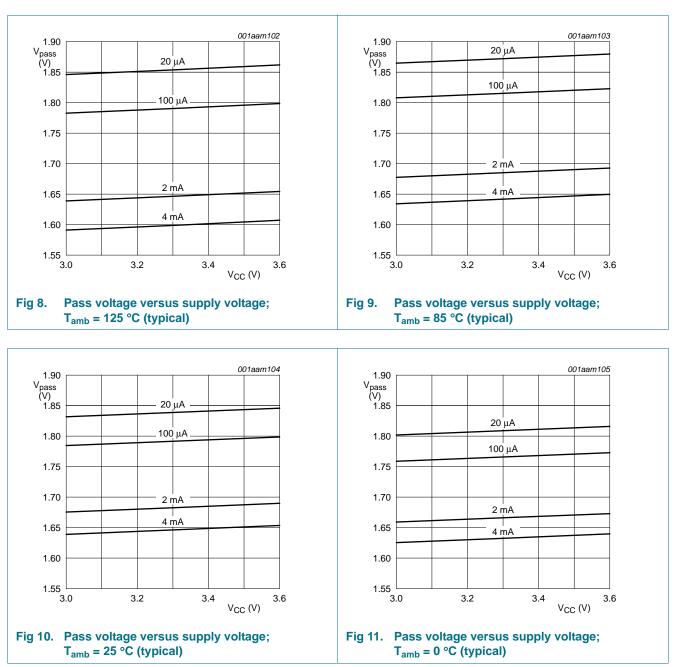




 $V_I = V_{CC}$  or GND and  $V_O$  = open circuit.

Fig 7. Test circuit for measuring ON-state leakage current (one switch)

8-bit level-shifting bus switch with 4-bit output enables

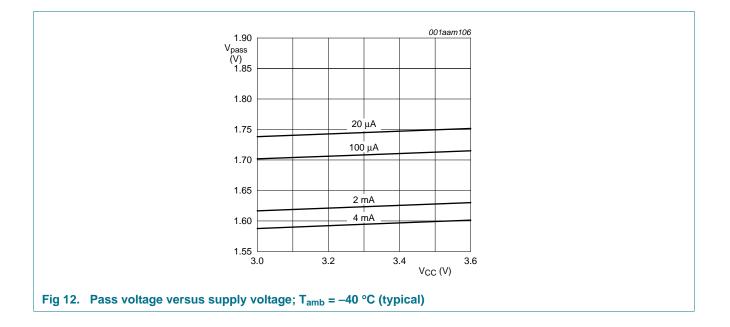


#### 9.2 Typical pass voltage graphs

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## 74CBTLVD3244

#### 8-bit level-shifting bus switch with 4-bit output enables



#### 8-bit level-shifting bus switch with 4-bit output enables

#### 9.3 ON resistance

#### Table 7. Resistance R<sub>ON</sub>

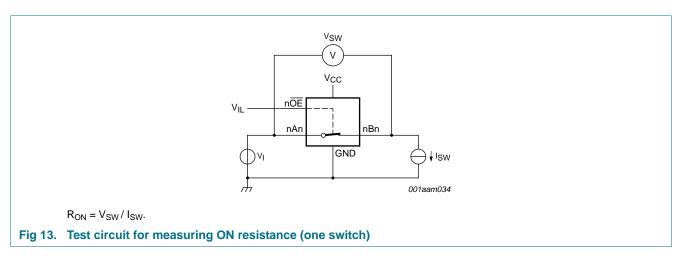
At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for test circuit see Figure 13.

Symbol	Parameter	Conditions	T <sub>amb</sub> =	–40 °C to	+85 °C	$T_{amb} = -40$ °	C to +125 °C	Unit
			Min	Тур <mark>[1]</mark>	Max	Min	Max	
R <sub>ON</sub> ON resista	ON resistance	$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$						
		$I_{SW} = 64 \text{ mA}; V_I = 0 \text{ V}$	-	3.7	7.0	-	10.0	Ω
		$I_{SW} = 24 \text{ mA}; V_I = 0 \text{ V}$	-	3.7	7.0	-	10.0	Ω
		$I_{SW}$ = 15 mA; $V_{I}$ = 1.2 V	-	4.7	10.0	-	12.0	Ω

[1] Typical values are measured at  $T_{amb}$  = 25 °C and nominal  $V_{CC}.$ 

[2] Measured by the voltage drop between the A and B terminals at the indicated current through the switch. ON-state resistance is determined by the lower of the voltages of the two (A or B) terminals.

#### 9.4 ON resistance test circuit



8-bit level-shifting bus switch with 4-bit output enables

#### **10.** Dynamic characteristics

#### Table 8. Dynamic characteristics

GND = 0 V; for test circuit see Figure 16

Symbol	Parameter	Conditions		T <sub>amb</sub> =	–40 °C to	+85 °C	T <sub>amb</sub> = -40 °	C to +125 °C	Unit
				Min	Typ <mark>[1]</mark>	Max	Min	Max	
t <sub>pd</sub> propagation delay		nAn to nBn or nBn to nAn; see <u>Figure 14</u>	<u>[2][3]</u>						
		$V_{CC}$ = 3.0 V to 3.6 V		-	-	0.11	-	0.22	ns
t <sub>en</sub>	enable time	n <mark>OE</mark> to nAn or nBn; see <u>Figure 15</u>	<u>[4]</u>						
		$V_{CC}$ = 3.0 V to 3.6 V		1.5	2.8	5.0	1.5	6.0	ns
t <sub>dis</sub>	disable time	n <mark>OE</mark> to nAn or nBn; see <u>Figure 15</u>	[5]						
		$V_{CC}$ = 3.0 V to 3.6 V		0.8	3.1	7.0	0.8	8.0	ns

[1] All typical values are measured at  $T_{amb}$  = 25  $^\circ C$  and at nominal  $V_{CC}.$ 

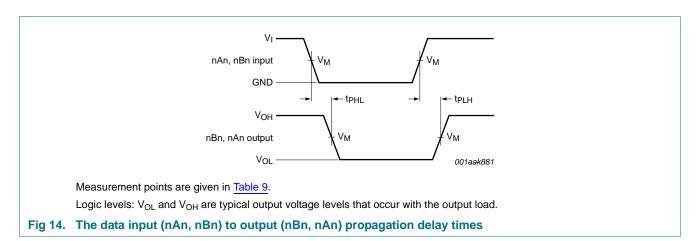
[2] The propagation delay is the calculated RC time constant of the on-state resistance of the switch and the load capacitance, when driven by an ideal voltage source (zero output impedance).

[3]  $t_{pd}$  is the same as  $t_{PLH}$  and  $t_{PHL}$ .

[4]  $t_{en}$  is the same as  $t_{PZH}$  and  $t_{PZL}$ .

[5]  $t_{dis}$  is the same as  $t_{PHZ}$  and  $t_{PLZ}$ .

#### 11. Waveforms



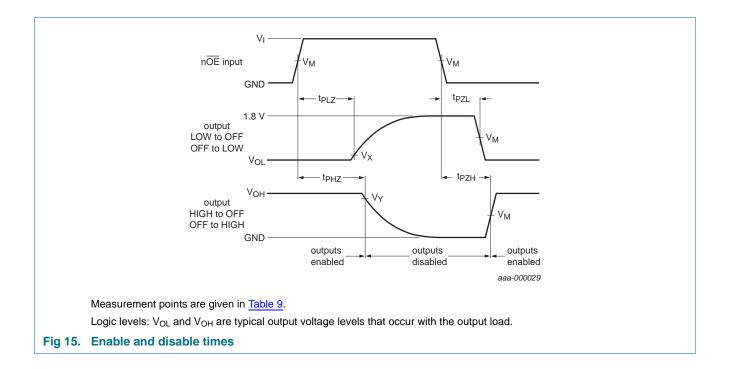
#### Table 9. Measurement points

Supply voltage	Input			Output		
V <sub>cc</sub>	V <sub>M</sub>	VI	$t_r = t_f$	V <sub>M</sub>	V <sub>X</sub>	V <sub>Y</sub>
3.0 V to 3.6 V	$0.5V_{CC}$	V <sub>CC</sub>	$\leq$ 2.0 ns	0.9 V	V <sub>OL</sub> + 0.15 V	V <sub>OH</sub> – 0.15 V

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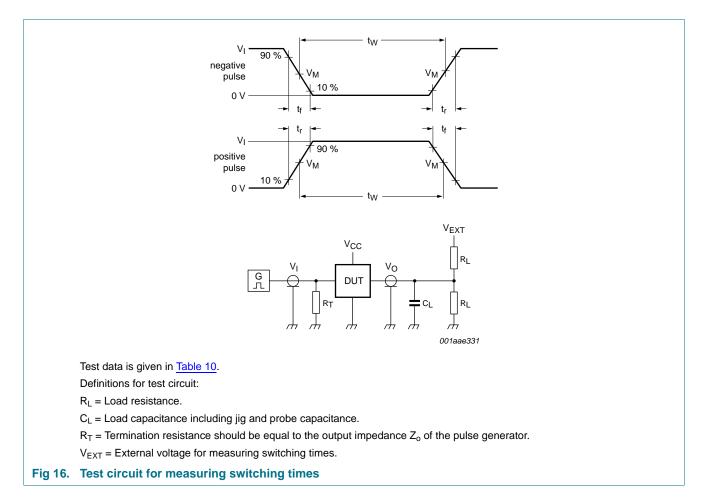
## 74CBTLVD3244

#### 8-bit level-shifting bus switch with 4-bit output enables



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#### 8-bit level-shifting bus switch with 4-bit output enables



#### Table 10. Test data

Supply voltage	Load		V <sub>EXT</sub>		
V <sub>cc</sub>	CL	R <sub>L</sub>	t <sub>PLH</sub> , t <sub>PHL</sub>	t <sub>PZH</sub> , t <sub>PHZ</sub>	t <sub>PZL</sub> , t <sub>PLZ</sub>
3.0 V to 3.6 V	30 pF	1 kΩ	open	GND	3.6 V

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#### 8-bit level-shifting bus switch with 4-bit output enables

#### **11.1 Additional dynamic characteristics**

#### Table 11. Additional dynamic characteristics

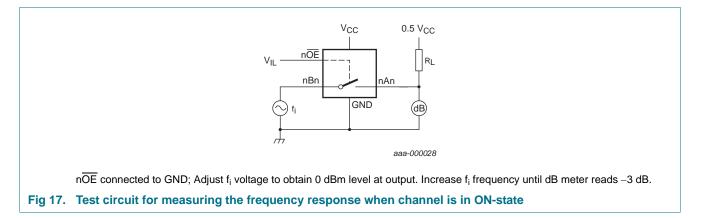
At recommended operating conditions; voltages are referenced to GND (ground = 0 V);  $V_I = GND$  or  $V_{CC}$  (unless otherwise specified);  $t_r = t_f \le 2.5$  ns.

Symbol	Parameter	Conditions		T <sub>amb</sub> = 25 °C			Unit
				Min	Тур	Max	
f <sub>(-3dB)</sub>	-3 dB frequency response	$V_{CC}$ = 3.3 V; $R_L$ = 50 $\Omega$ ; see Figure 17	[2]	-	575	-	MHz

[1] Typical values are measured at  $T_{amb}$  = 25  $^\circ C$  and  $V_{CC}$  = 3.3 V.

[2]  $f_i$  is biased at 0.5V<sub>CC</sub>.

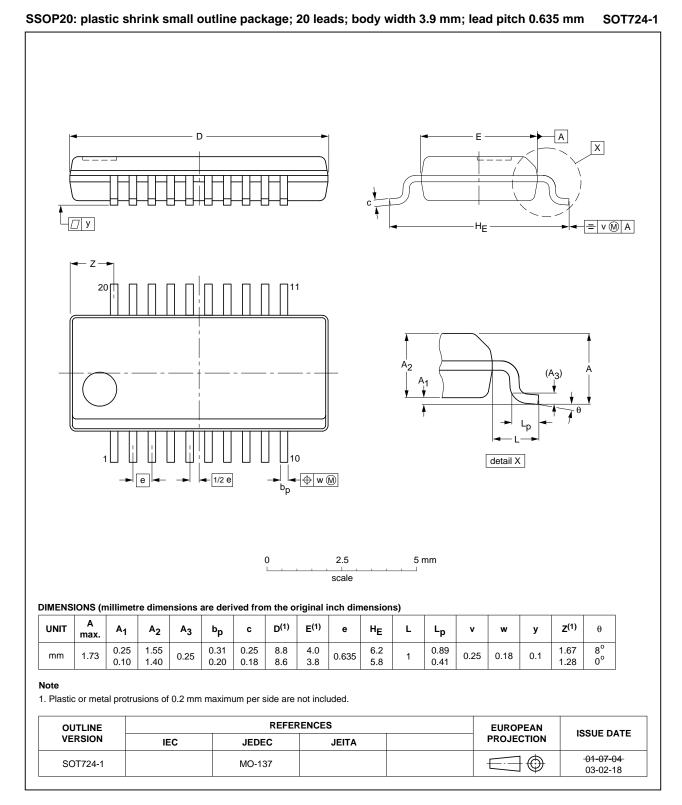
#### 11.2 Test circuits



## 74CBTLVD3244

8-bit level-shifting bus switch with 4-bit output enables

#### 12. Package outline



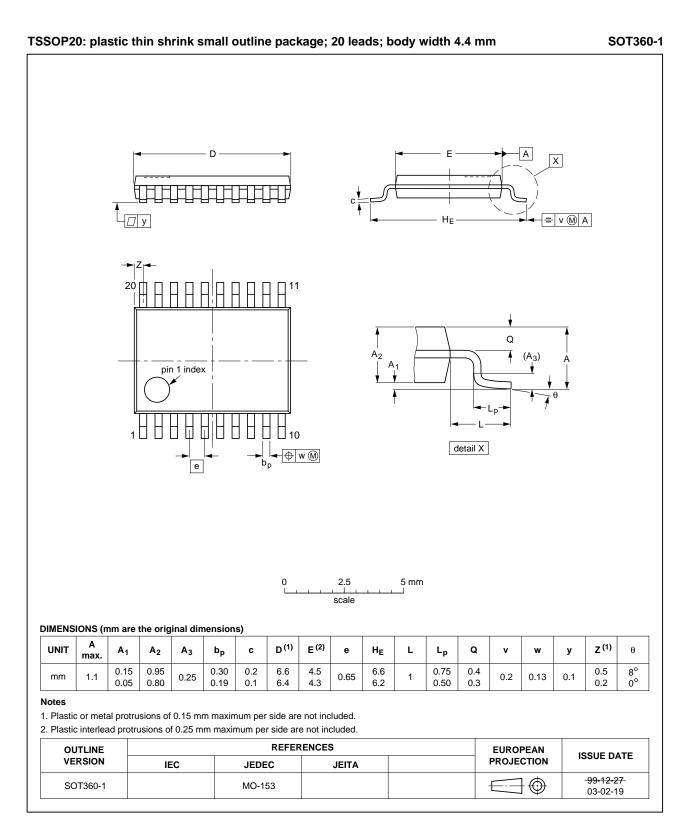
#### Fig 18. Package outline SOT724-1 (SSOP20)

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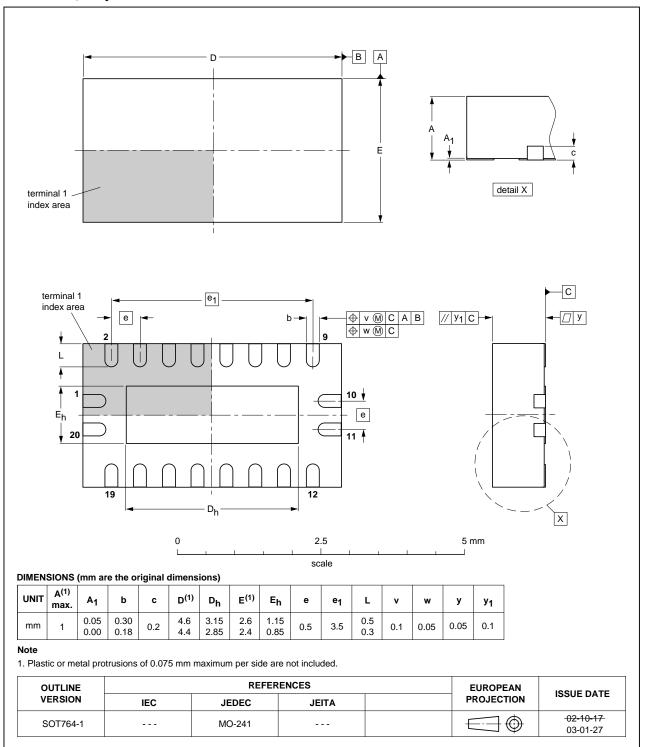


#### Fig 19. Package outline SOT360-1 (TSSOP20)

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8-bit level-shifting bus switch with 4-bit output enables



DHVQFN20: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 20 terminals; body 2.5 x 4.5 x 0.85 mm SOT764-1

#### Fig 20. Package outline SOT764-1 (DHVQFN20)

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## **13. Abbreviations**

Acronym CDM CMOS	Description Charged Device Model Complementary Metal-Oxide Semiconductor
CMOS	Complementary Metal-Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
НВМ	Human Body Model
MM	Machine Model
TTL	Transistor-Transistor Logic

## 14. Revision history

Table 13. Revision h	istory			
Document ID	Release date	Data sheet status	Change notice	Supersedes
74CBTLVD3244 v.2	20111216	Product data sheet	-	74CBTLVD3244 v.1
Modifications:	<ul> <li>Legal pages</li> </ul>	updated.		
74CBTLVD3244 v.1	20110715	Product data sheet	-	-

8-bit level-shifting bus switch with 4-bit output enables

#### **15. Legal information**

#### 15.1 Data sheet status

Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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#### 8-bit level-shifting bus switch with 4-bit output enables

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8-bit level-shifting bus switch with 4-bit output enables

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